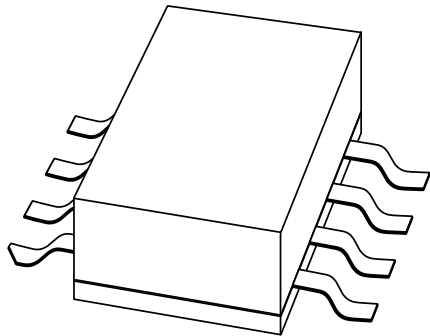


# DATA SHEET



## **BLT52** UHF power transistor

Product specification  
Supersedes data of 1997 Oct 15

1998 Jan 28

# UHF power transistor

# BLT52

### FEATURES

- Emitter ballasting resistors for an optimum temperature profile
- Gold metallization ensures excellent reliability.

### APPLICATIONS

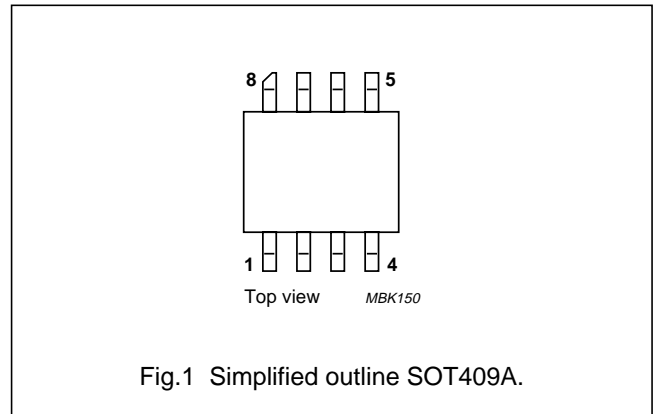
- Common emitter class-B operation in portable radio transmitters in the 470 MHz communication band.

### DESCRIPTION

NPN silicon planar epitaxial power transistor encapsulated in a ceramic SOT409A SMD package.

### PINNING

PIN	DESCRIPTION
1, 4, 5, 8	emitter
2, 3	base
6, 7	collector



### QUICK REFERENCE DATA

RF performance at  $T_{mb} \leq 60 \text{ }^\circ\text{C}$  in a common emitter test circuit.

MODE OF OPERATION	f (MHz)	$V_{CE}$ (V)	$P_L$ (W)	$G_p$ (dB)	$\eta_c$ (%)
CW, class-B	470	7.5	7	$\geq 8$ typ. 9.5	$\geq 50$ typ. 65
		6	3	$\geq 8$ typ. 9.5	$\geq 50$ typ. 55

# UHF power transistor

BLT52

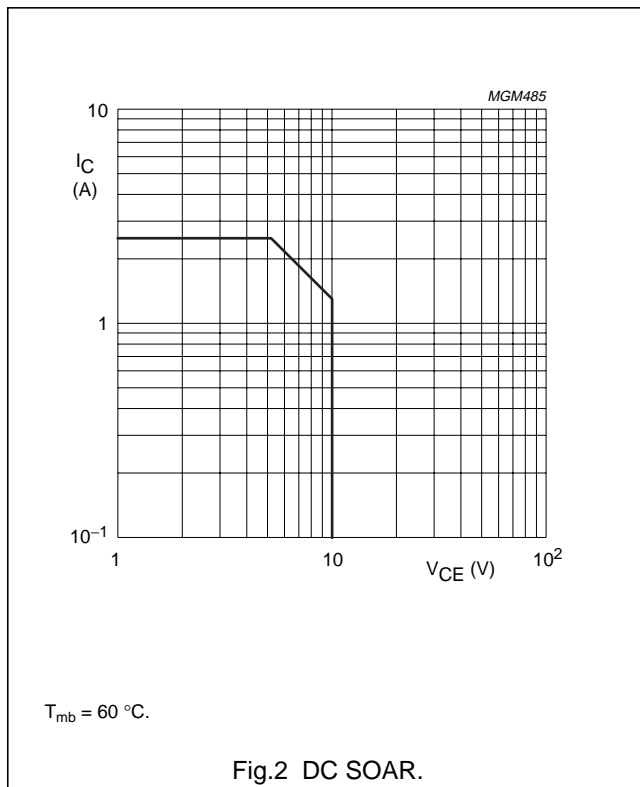
## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	20	V
$V_{CEO}$	collector-emitter voltage	open base	–	10	V
$V_{EBO}$	emitter-base voltage	open collector	–	3	V
$I_C$	collector current (DC)		–	2.5	A
$P_{tot}$	total power dissipation	$T_{mb} \leq 60\text{ °C}$	–	13	W
$T_{stg}$	storage temperature		–65	+150	°C
$T_j$	operating junction temperature		–	200	°C

## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-mb}$	thermal resistance from junction to mounting base	$P_{tot} = 13\text{ W}; T_{mb} \leq 60\text{ °C}$	8	K/W



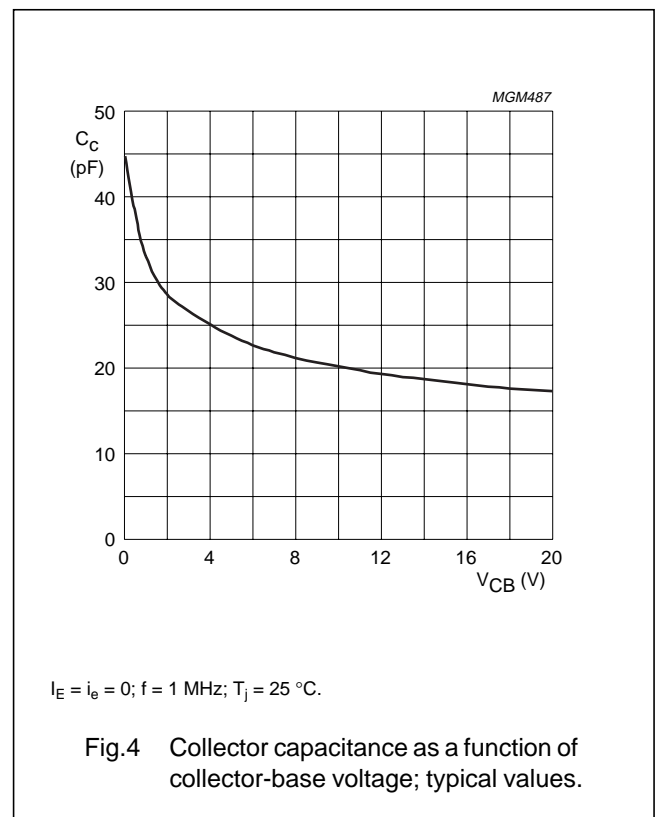
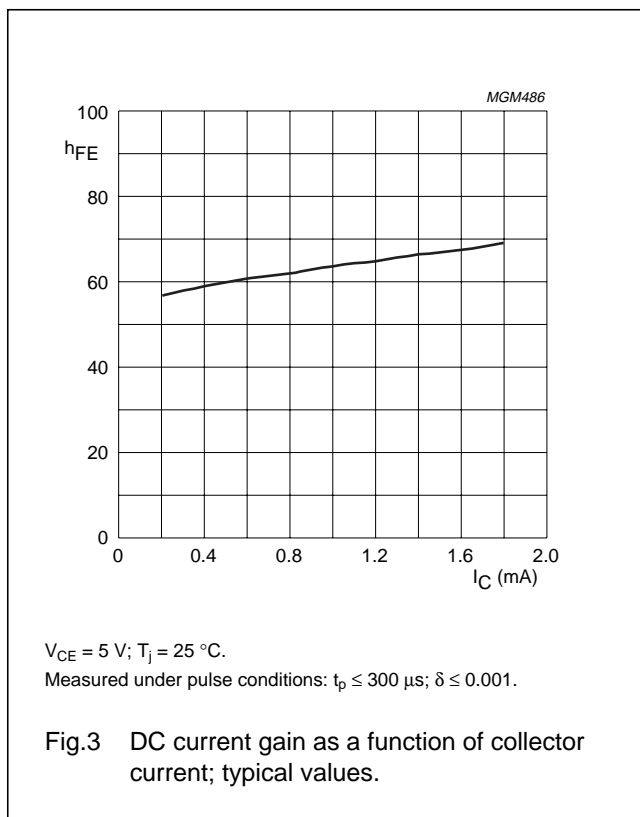
UHF power transistor

BLT52

**CHARACTERISTICS**

$T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)CBO}$	collector-base breakdown voltage	open emitter; $I_C = 20\text{ mA}$	20	–	–	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	open base; $I_C = 40\text{ mA}$	10	–	–	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	open collector; $I_E = 4\text{ mA}$	3	–	–	V
$I_{CES}$	collector leakage current	$V_{BE} = 0; V_{CE} = 7.5\text{ V}$	–	–	1	mA
$h_{FE}$	DC current gain	$I_C = 1.2\text{ A}; V_{CE} = 5\text{ V}$	25	–	–	
$C_c$	collector capacitance	$I_E = i_e = 0; V_{CB} = 7.5\text{ V}; f = 1\text{ MHz}$	–	24	–	pF
$C_{re}$	feedback capacitance	$I_C = 0; V_{CE} = 7.5\text{ V}; f = 1\text{ MHz}$	–	17	–	pF



# UHF power transistor

# BLT52

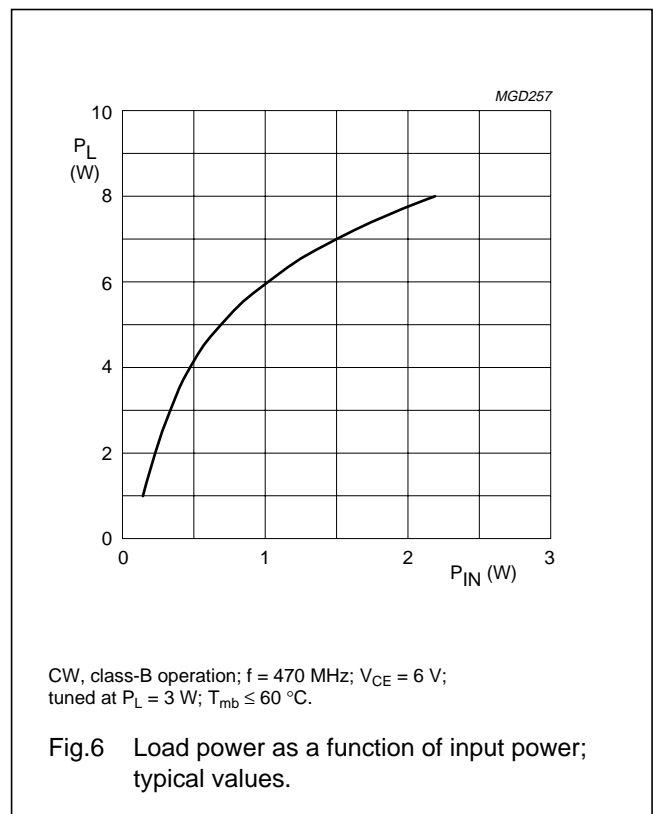
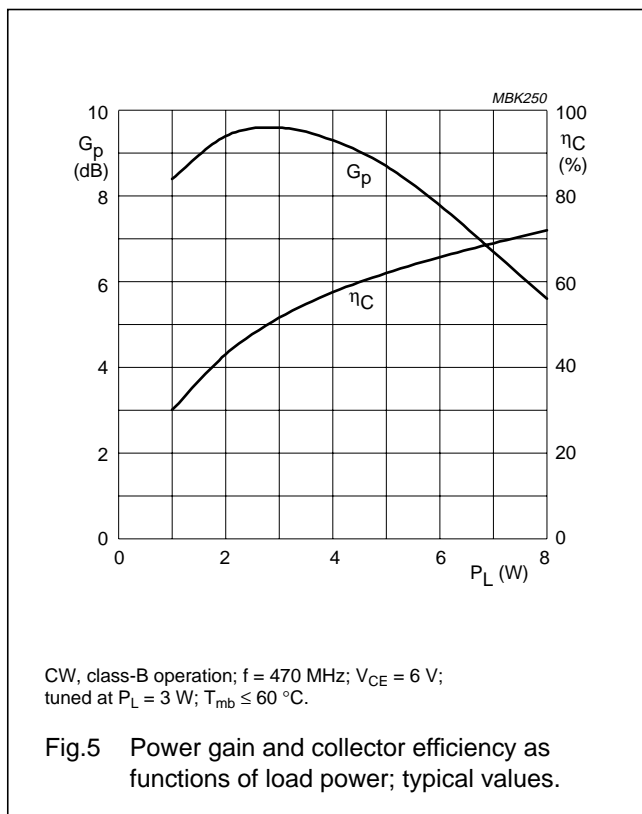
## APPLICATION INFORMATION

RF performance at  $T_{mb} \leq 60\text{ }^\circ\text{C}$  in a common emitter test circuit.

MODE OF OPERATION	f (MHz)	V <sub>CE</sub> (V)	P <sub>L</sub> (W)	G <sub>p</sub> (dB)	$\eta_c$ (%)
CW, class-B	470	7.5	7	$\geq 8$ typ. 9.5	$\geq 50$ typ. 65
		6	3	$\geq 8$ typ. 9.5	$\geq 50$ typ. 55

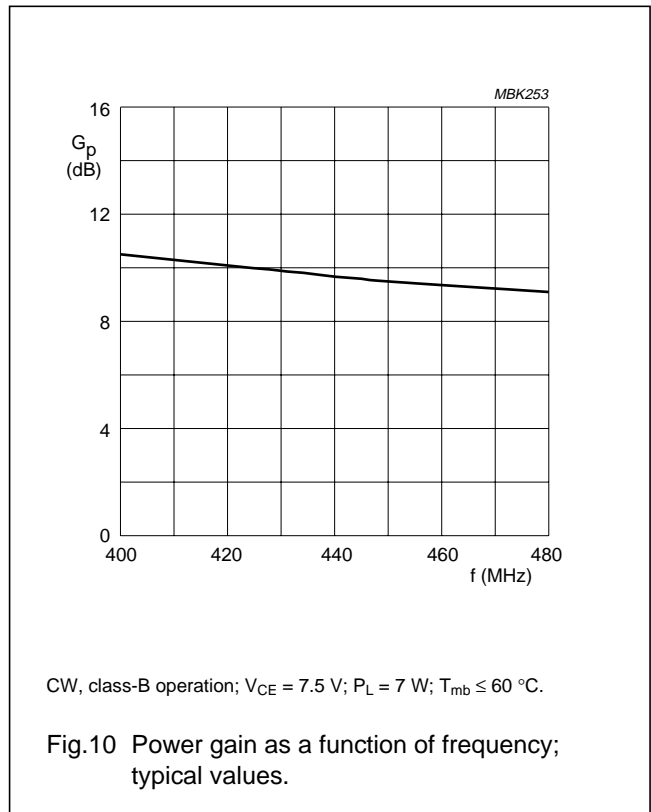
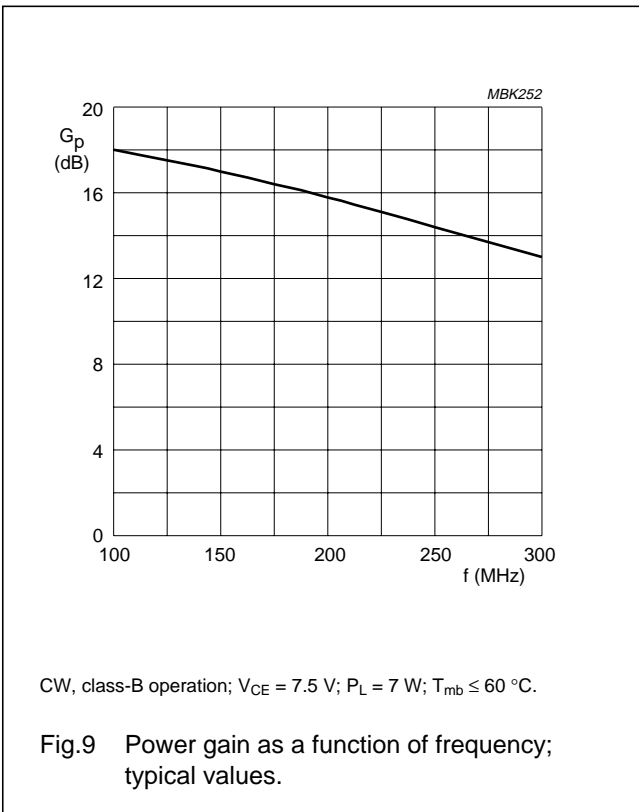
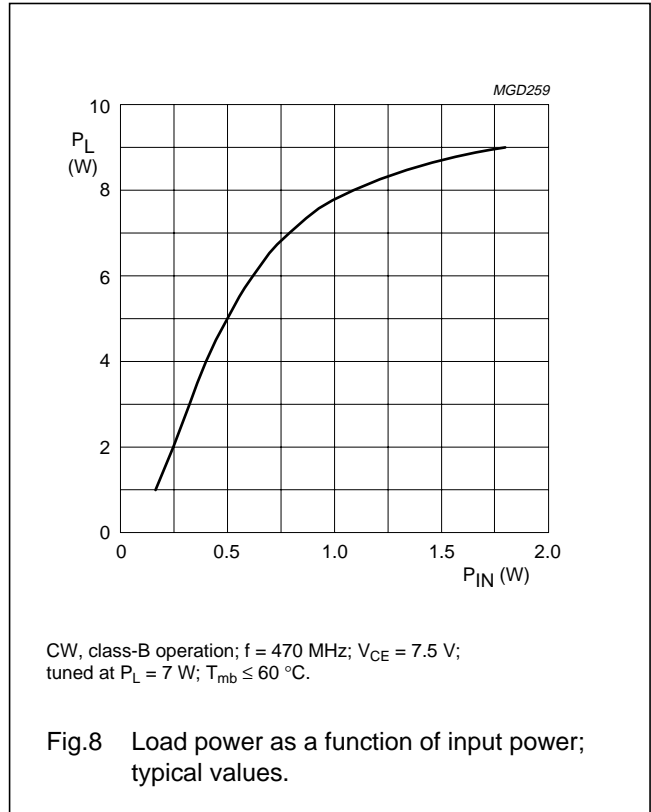
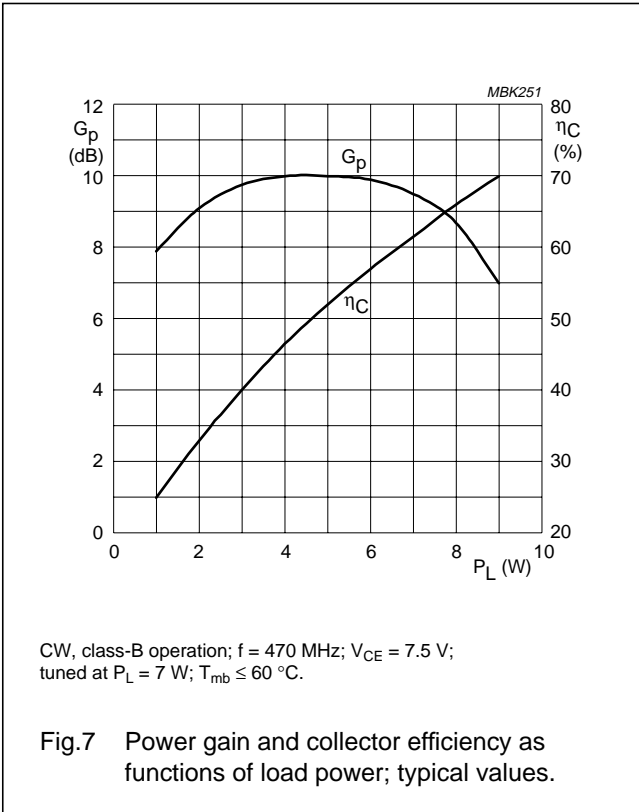
### Ruggedness in class-B operation

The BLT52 is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: CW, class-B operation; f = 470 MHz; V<sub>CE</sub> = 9 V and P<sub>L</sub> = 7 W; T<sub>mb</sub> ≤ 60 °C.



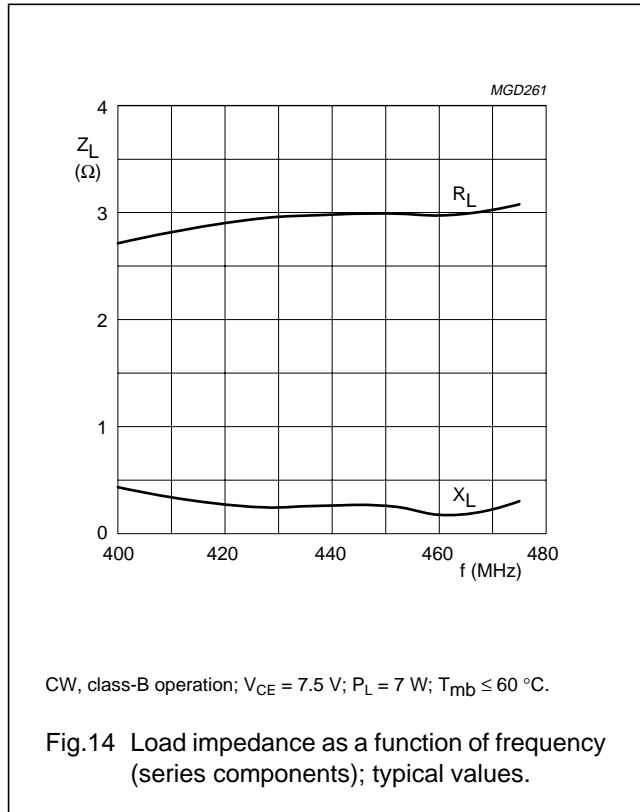
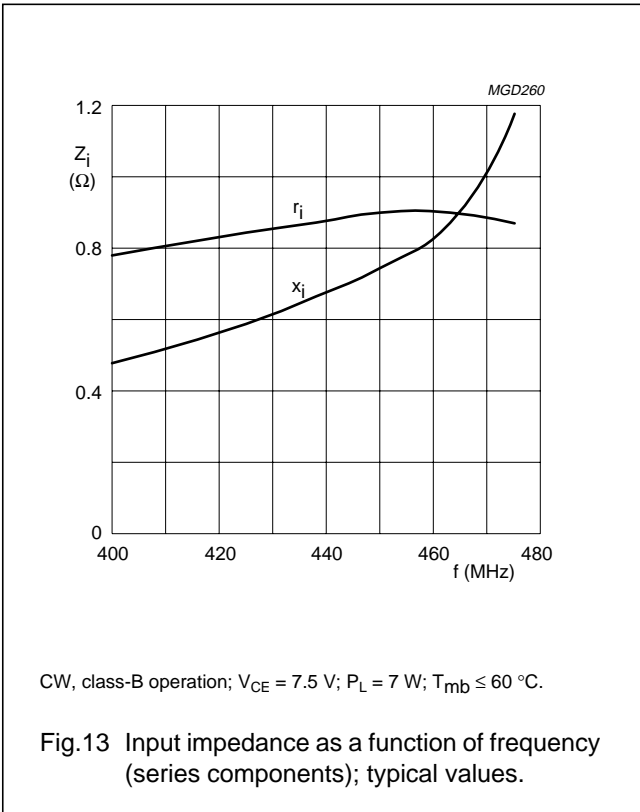
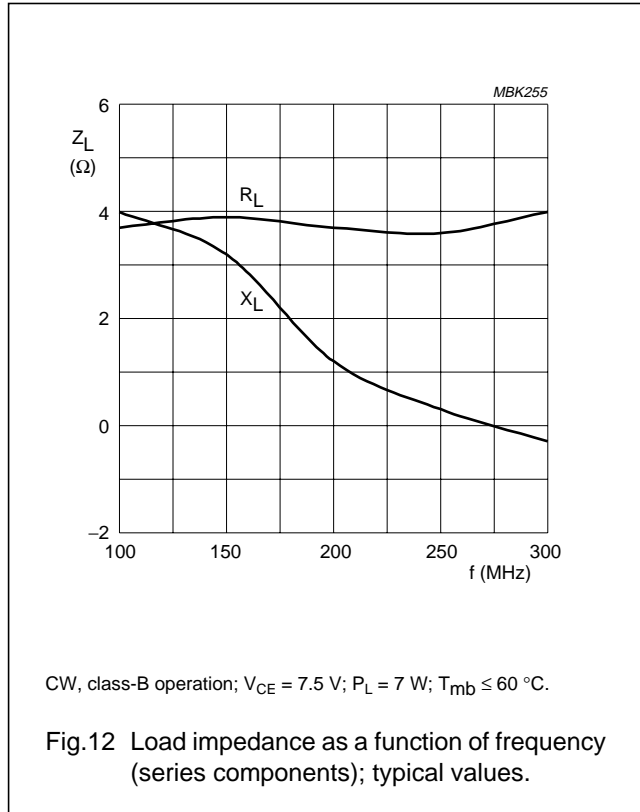
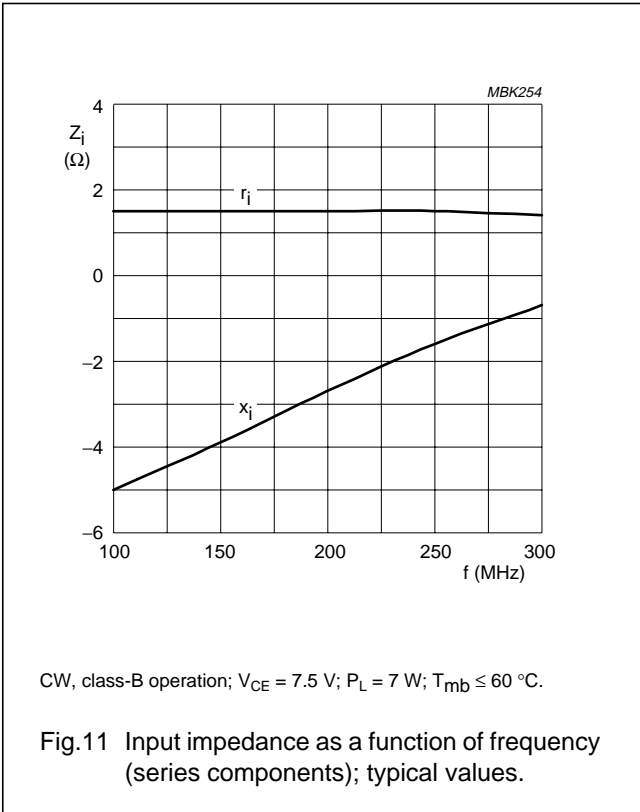
UHF power transistor

BLT52



UHF power transistor

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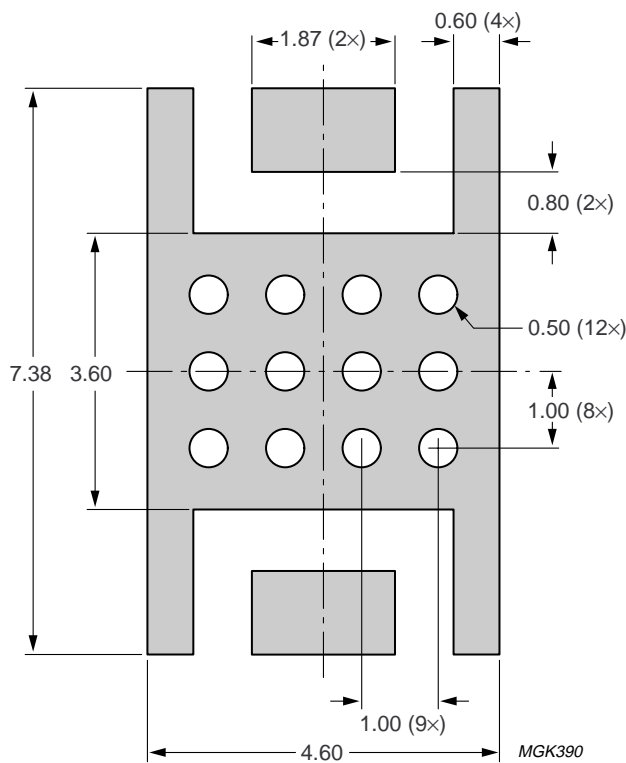
UHF power transistor

BLT52

**MOUNTING RECOMMENDATIONS**

Both the metallized groundplate and leads contribute to the heatflow. It is recommended that the transistor is mounted on a grounded metallized area of a maximum thickness of 0.8 mm on the printed-circuit board, equipped with at least 12 (0.5 mm diameter) through metallized holes filled with solder.

A thermal resistance  $R_{th(mb-h)}$  of 5 K/W can be achieved if heatsink compound is applied when the transistor is mounted on the printed-circuit board.



Dimensions in mm.

Fig.15 Reflow soldering footprint for SOT409A.



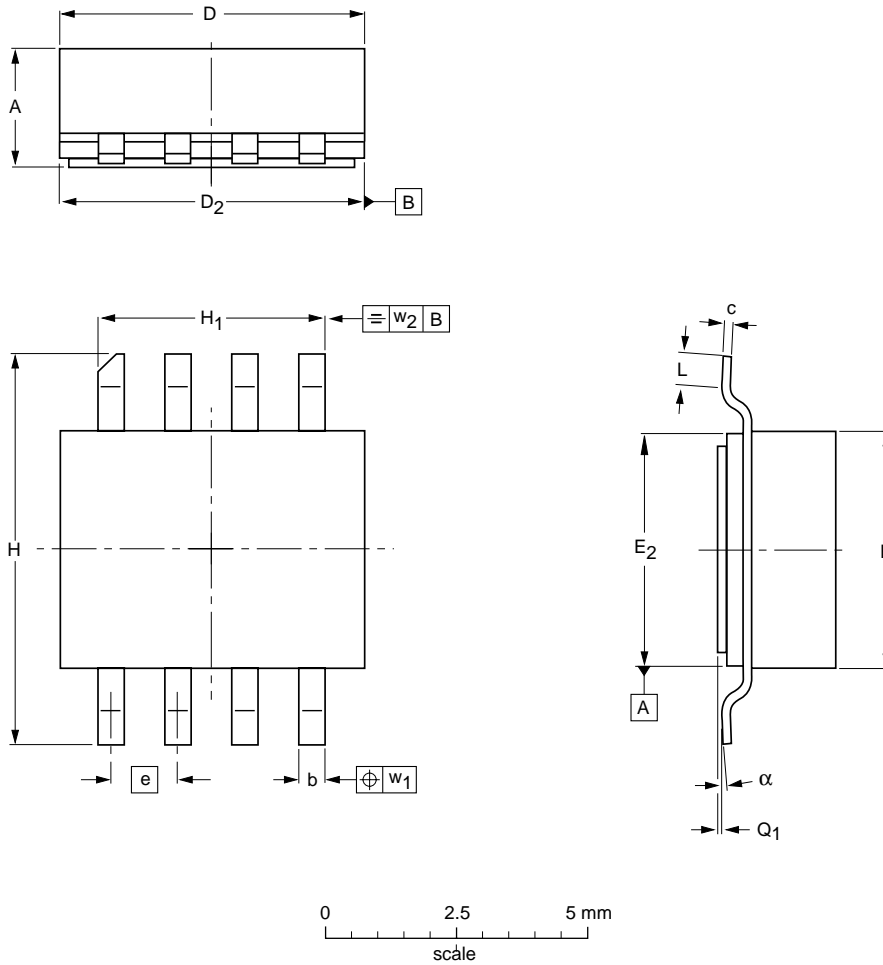
UHF power transistor

BLT52

PACKAGE OUTLINE

Ceramic surface mounted package; 8 leads

SOT409A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	c	D	D <sub>2</sub>	E	E <sub>2</sub>	e	H	H <sub>1</sub>	L	Q <sub>1</sub>	w <sub>1</sub>	w <sub>2</sub>	α
mm	2.36 2.06	0.58 0.43	0.23 0.18	5.94 5.03	5.16 5.00	4.93 4.01	4.14 3.99	1.27	7.47 7.26	4.39 4.24	1.02 0.51	0.10 0.00	0.25	0.25	7° 0°
inches	0.093 0.081	0.023 0.017	0.009 0.007	0.234 0.198	0.203 0.197	0.194 0.158	0.163 0.157	0.050	0.294 0.286	0.173 0.167	0.040 0.020	0.004 0.000	0.010	0.010	7° 0°

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT409A						97-06-28

## UHF power transistor

BLT52

**DEFINITIONS**

<b>Data Sheet Status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	

**LIFE SUPPORT APPLICATIONS**

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UHF power transistor

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